## EE309 Advanced Programming Techniques for EE

## Lecture 24: Modern systems

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[Slides from 15-213: Introduction to Computer Systems at CMU]

## Systems

 A system is any collection of components combined to create an entity that is intended to accomplish some particular task(s) or goal(s).

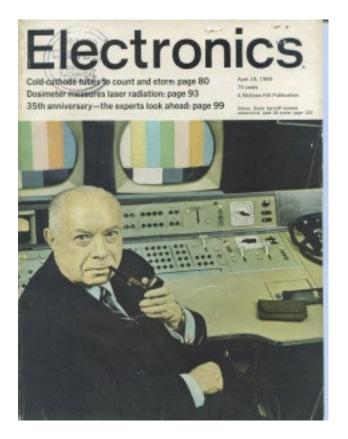
Three properties

- Correctness: To accomplish the goal
- Performance: To accomplish the goal with many users
- Security: To accomplish the goal with even malicious users

## What we have studied

- Files IO
- Allocation
- Buffer overflow
- Network programming
- Concurrent programming
- Cryptography

## **Moore's Law Origins**



#### April 19, 1965



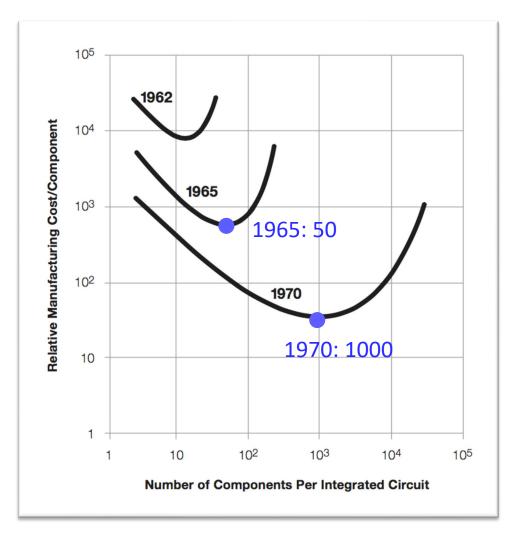
# Cramming more components onto integrated circuits

With unit cost falling as the number of components per circuit rises, by 1975 economics may dictate squeezing as many as 65,000 components on a single silicon chip

#### By Gordon E. Moore

Director, Research and Development Laboratories, Fairchild Semiconductor division of Fairchild Camera and Instrument Corp.

## **Moore's Law Origins**



#### **Moore's Thesis**

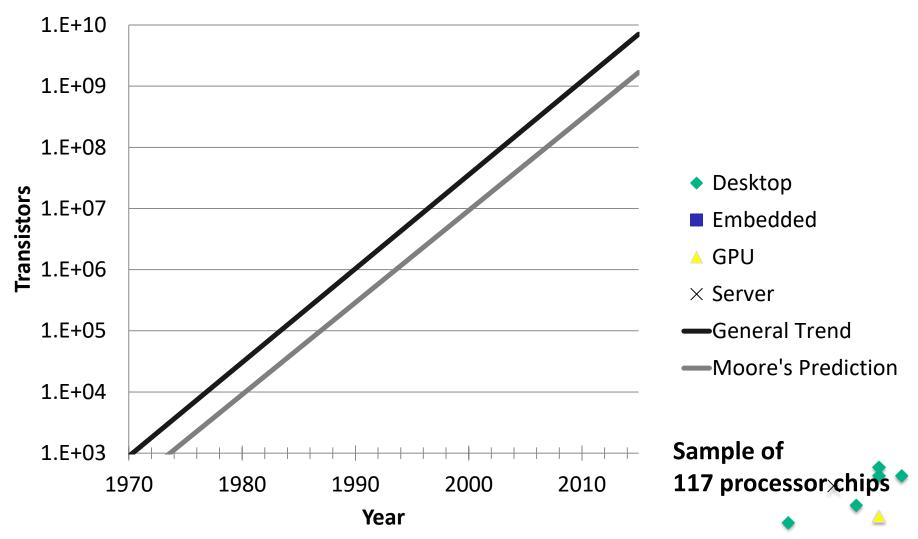
- Minimize price per device
- Optimum number of devices
  / chip increasing 2x / year

#### Later

- 2x / 2 years
- "Moore's Prediction"

## Moore's Law: 50 Years

**Transistor Count by Year** 



## What Moore's Law Has Meant



#### 1976 Cray 1

- 250 M Ops/second
- ~170,000 chips
- 0.5B transistors
- 5,000 kg, 115 KW
- \$9M
- 80 manufactured

#### **2014** iPhone 6

- > 4 B Ops/second
- ~10 chips
- > 3B transistors
- 120 g, < 5 W
- **\$649**
- 10 million sold in first 3 days

## What Moore's Law Has Meant

### 1965 Consumer Product



### 2015 Consumer Product





Apple A8 Processor 2 B transistors

## What Moore's Law Could Mean

2015 Consumer Product



2065 Consumer Product



- Portable
- Low power
- Will drive markets & innovation

## **Requirements for Future Technology**

Must be suitable for portable, low-power operation

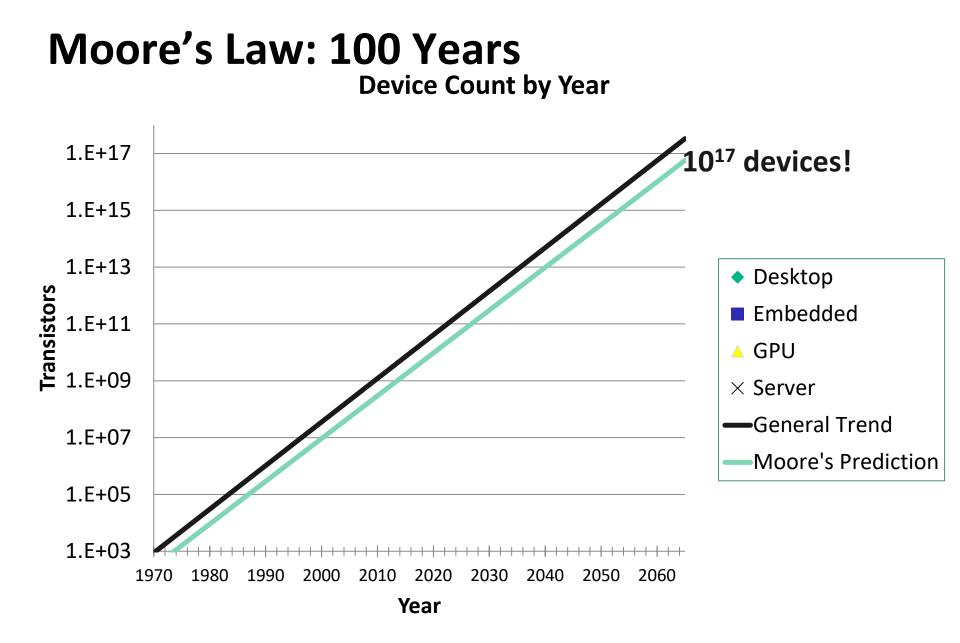
- Consumer products
- Internet of Things components
- Not cryogenic, not quantum

#### Must be inexpensive to manufacture

- Comparable to current semiconductor technology
  - O(1) cost to make chip with O(N) devices

#### Need not be based on transistors

- Memristors, carbon nanotubes, DNA transcription, ...
- Possibly new models of computation
- But, still want lots of devices in an integrated system



## Visualizing 10<sup>17</sup> Devices

If devices were the size of a grain of sand



0.1 m<sup>3</sup> 3.5 X 10<sup>9</sup> grains



1 million m<sup>3</sup> 0.35 X 10<sup>17</sup> grains

## **Increasing Transistor Counts**

## **1.** Chips have gotten bigger

1 area doubling / 10 years

### 2. Transistors have gotten smaller

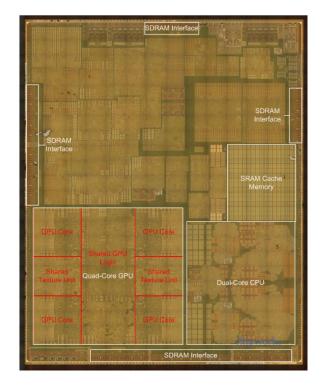
4 density doublings / 10 years

### Will these trends continue?

## **Reaching 2065 Goal**

#### Target

- 10<sup>17</sup> devices
- 400 mm<sup>2</sup>
- L = 63 pm

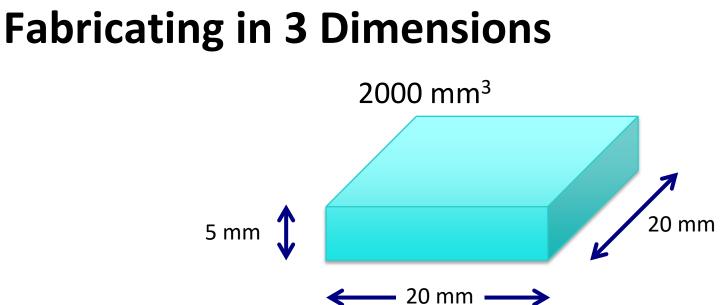




#### Is this possible?



## Not with 2-d fabrication



#### Parameters

- 10<sup>17</sup> devices
- 100,000 logical layers
  - Each 50 nm thick
  - ~1,000,000 physical layers
    - To provide wiring and isolation
- L = 20 nm
  - 10x smaller than today



2065 mm<sup>3</sup>

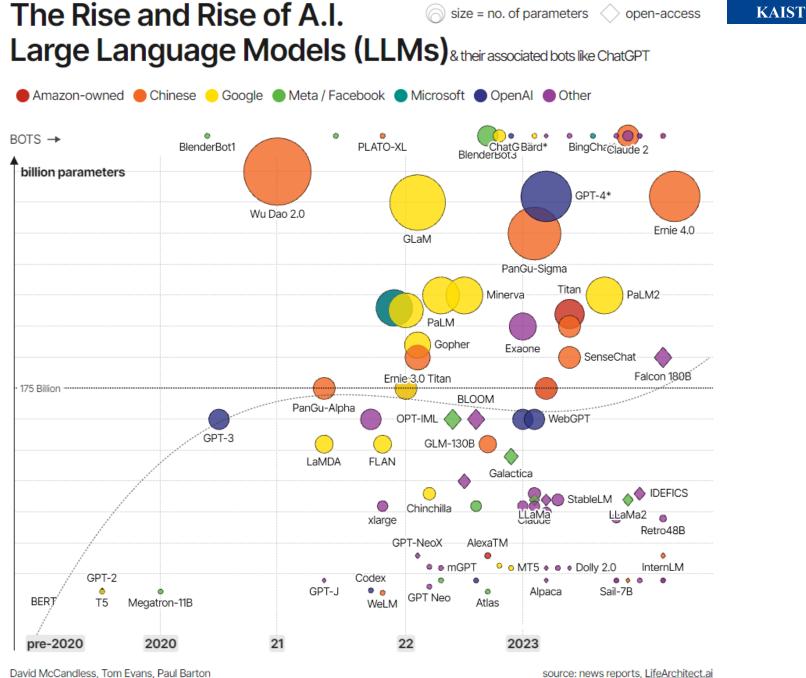
## **Towards scalability**



## **Distributed system**

## Distributed System



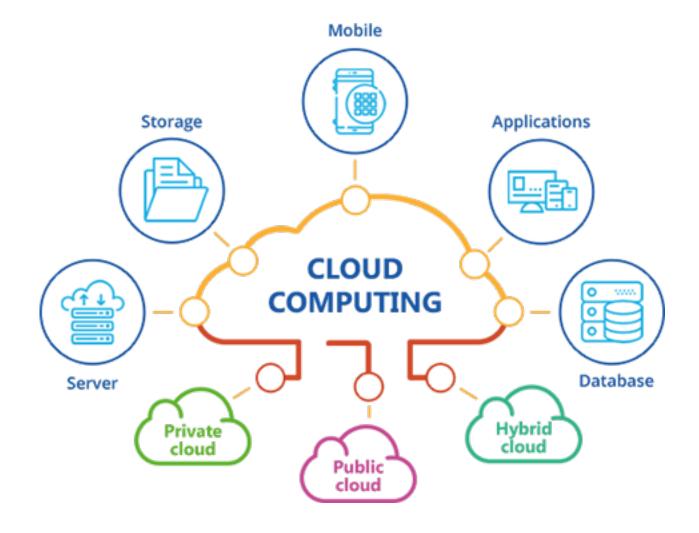


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source: news reports, LifeArchitect.ai

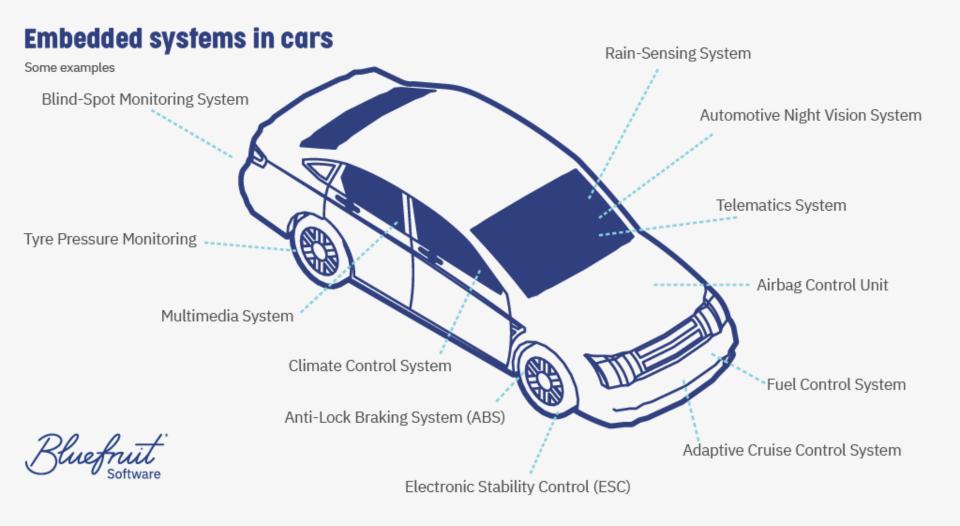
\* = parameters undisclosed // see the data

## **Cloud computing**



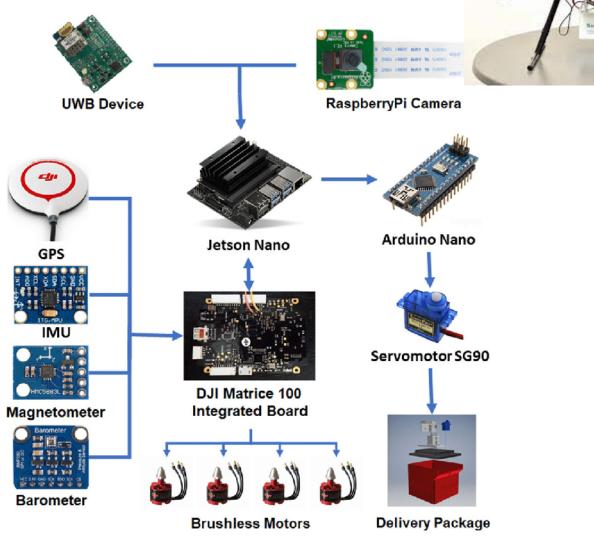
## **Cyber Physical Systems**

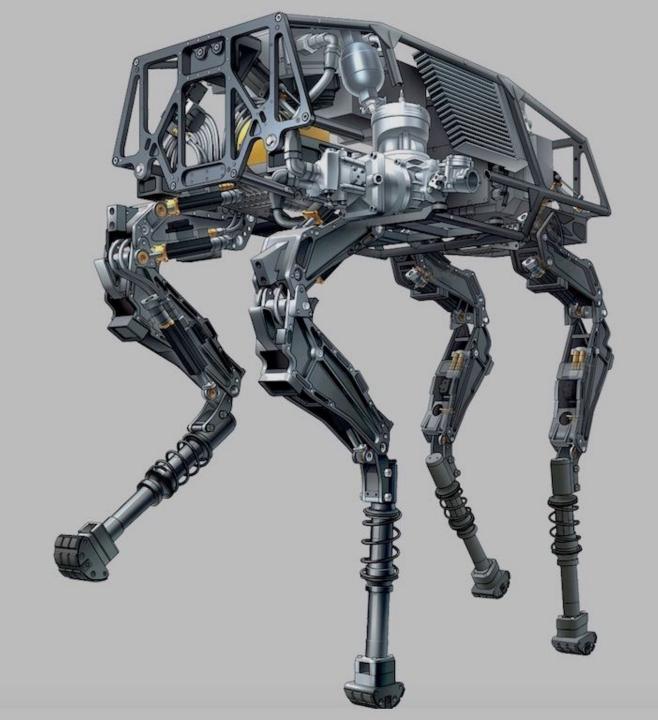




CADMI

## **Cyber Physical Systems**





## **Operating system**



## Next courses?

- **EE323: Computer network**
- EE324: Network programming
- **EE412: Introduction to Big Data analytics**
- EE414: Embedded system
- **EE415:** Operating system for Electrical engineering